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### What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

### Applications of "[Embedded - Microcontrollers](#)"

#### Details

Product Status	Obsolete
Core Processor	Z8
Core Size	8-Bit
Speed	8MHz
Connectivity	-
Peripherals	HLVD, POR, WDT
Number of I/O	24
Program Memory Size	4KB (4K x 8)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	237 x 8
Voltage - Supply (Vcc/Vdd)	2V ~ 3.6V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Surface Mount
Package / Case	28-SSOP (0.209", 5.30mm Width)
Supplier Device Package	-
Purchase URL	<a href="https://www.e-xfl.com/product-detail/zilog/zgp323leh2804g">https://www.e-xfl.com/product-detail/zilog/zgp323leh2804g</a>

- Port 1: 0–3 pull-up transistors
- Port 1: 4–7 pull-up transistors
- Port 2: 0–7 pull-up transistors
- EPROM Protection
- WDT enabled at POR

► **Note:** The mask option pull-up transistor has a *typical* equivalent resistance of 200 K $\Omega$   $\pm$ 50% at  $V_{CC}$ =3 V and 450 K $\Omega$   $\pm$ 50% at  $V_{CC}$ =2 V.

## General Description

The Z8 GP™ OTP MCU Family is an OTP-based member of the MCU family of infrared microcontrollers. With 237B of general-purpose RAM and up to 32KB of OTP, ZiLOG®'s CMOS microcontrollers offer fast-executing, efficient use of memory, sophisticated interrupts, input/output bit manipulation capabilities, automated pulse generation/reception, and internal key-scan pull-up transistors.

The Z8 GP™ OTP MCU Family architecture (Figure 1) is based on ZiLOG's 8-bit microcontroller core with an Expanded Register File allowing access to register-mapped peripherals, input/output (I/O) circuits, and powerful counter/timer circuitry. The Z8® offers a flexible I/O scheme, an efficient register and address space structure, and a number of ancillary features that are useful in many consumer, automotive, computer peripheral, and battery-operated hand-held applications.

There are three basic address spaces available to support a wide range of configurations: Program Memory, Register File and Expanded Register File. The register file is composed of 256 Bytes (B) of RAM. It includes 4 I/O port registers, 16 control and status registers, and 236 general-purpose registers. The Expanded Register File consists of two additional register groups (F and D).

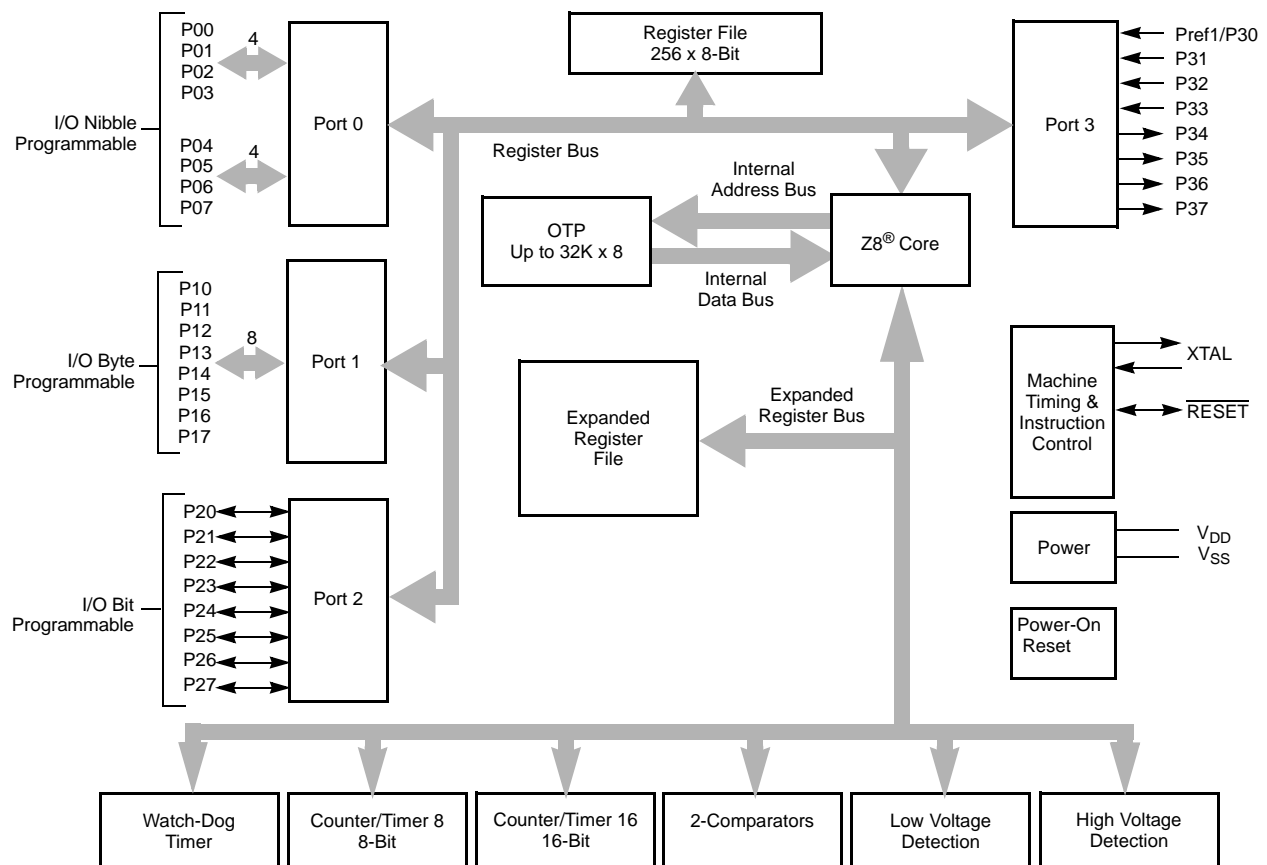
To unburden the program from coping with such real-time problems as generating complex waveforms or receiving and demodulating complex waveform/pulses, the Z8 GP OTP MCU offers a new intelligent counter/timer architecture with 8-bit and 16-bit counter/timers (see Figure 2). Also included are a large number of user-selectable modes and two on-board comparators to process analog signals with separate reference voltages.

► **Note:** All signals with an overline, " $\overline{\phantom{x}}$ ", are active Low. For example,  $\overline{B/W}$ , in which WORD is active Low, and  $\overline{B/W}$ , in which BYTE is active Low.

Power connections use the conventional descriptions listed in Table 2.

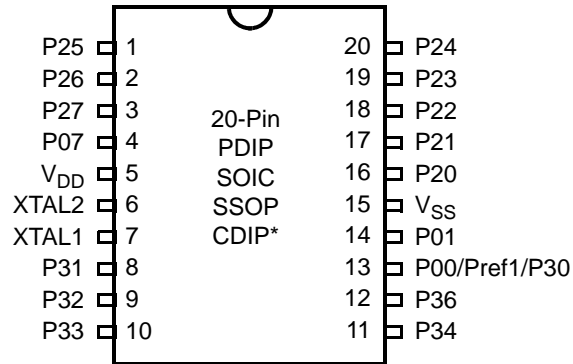
**Table 2. Power Connections**

Connection	Circuit	Device
Power	V <sub>CC</sub>	V <sub>DD</sub>
Ground	GND	V <sub>SS</sub>



Note: Refer to the specific package for available pins.

**Figure 1. Functional Block Diagram**



**Figure 3. 20-Pin PDIP/SOIC/SSOP/CDIP\* Pin Configuration**

**Table 3. 20-Pin PDIP/SOIC/SSOP/CDIP\* Pin Identification**

Pin #	Symbol	Function	Direction
1–3	P25–P27	Port 2, Bits 5,6,7	Input/Output
4	P07	Port 0, Bit 7	Input/Output
5	V <sub>DD</sub>	Power Supply	
6	XTAL2	Crystal Oscillator Clock	Output
7	XTAL1	Crystal Oscillator Clock	Input
8–10	P31–P33	Port 3, Bits 1,2,3	Input
11,12	P34, P36	Port 3, Bits 4,6	Output
13	P00/Pref1/P30	Port 0, Bit 0/Analog reference input Port 3 Bit 0	Input/Output for P00 Input for Pref1/P30
14	P01	Port 0, Bit 1	Input/Output
15	V <sub>SS</sub>	Ground	
16–20	P20–P24	Port 2, Bits 0,1,2,3,4	Input/Output

► **Note:** \*Windowed Cerdip. These units are intended to be used for engineering code development only. ZiLOG does not recommend/guarantee this package for production use.

## Absolute Maximum Ratings

Stresses greater than those listed in Table 7 might cause permanent damage to the device. This rating is a stress rating only. Functional operation of the device at any condition above those indicated in the operational sections of these specifications is not implied. Exposure to absolute maximum rating conditions for an extended period might affect device reliability.

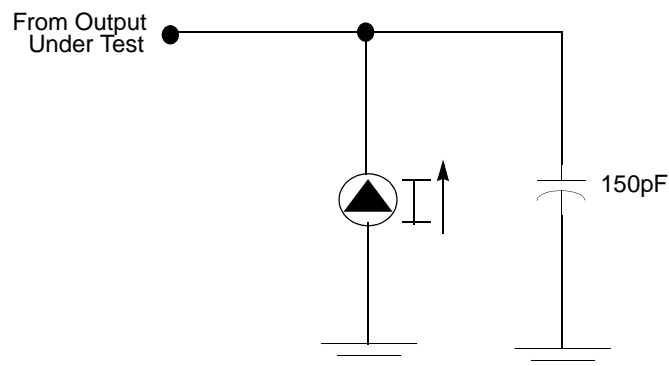
**Table 6. Absolute Maximum Ratings**

Parameter	Minimum	Maximum	Units	Notes
Ambient temperature under bias	0	+70	C	
Storage temperature	−65	+150	C	
Voltage on any pin with respect to $V_{SS}$	−0.3	+5.5	V	1
Voltage on $V_{DD}$ pin with respect to $V_{SS}$	−0.3	+3.6	V	
Maximum current on input and/or inactive output pin	−5	+5	$\mu$ A	
Maximum output current from active output pin	−25	+25	mA	
Maximum current into $V_{DD}$ or out of $V_{SS}$		75	mA	

Notes:  
This voltage applies to all pins except the following:  $V_{DD}$ , P32, P33 and  $\overline{\text{RESET}}$ .

## Standard Test Conditions

The characteristics listed in this product specification apply for standard test conditions as noted. All voltages are referenced to GND. Positive current flows into the referenced pin (see Figure 7).



**Figure 7. Test Load Diagram**

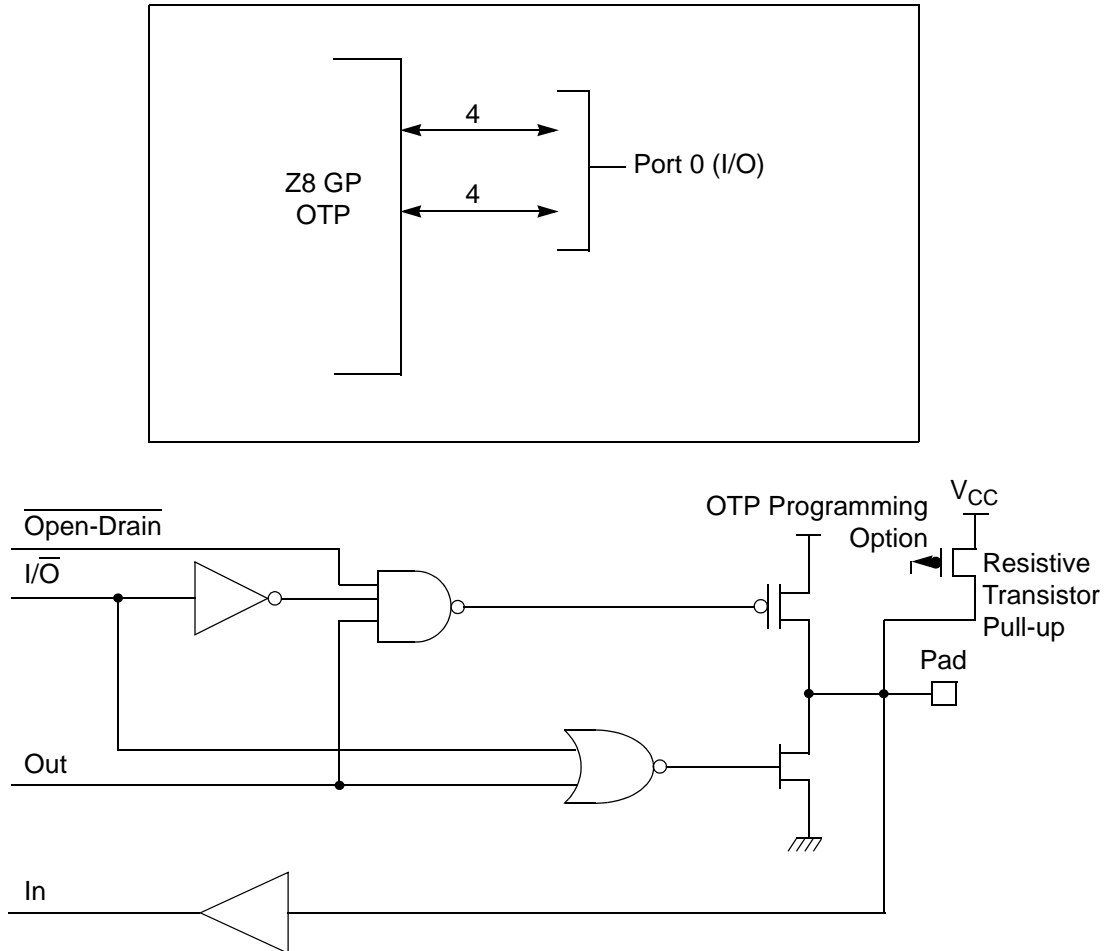


Figure 9. Port 0 Configuration

### Port 1 (P17–P10)

Port 1 (see Figure 10) Port 1 can be configured for standard port input or output mode. After POR, Port 1 is configured as an input port. The output drivers are either push-pull or open-drain and are controlled by bit D1 in the PCON register.

► **Note:** The Port 1 direction is reset to be input following an SMR.

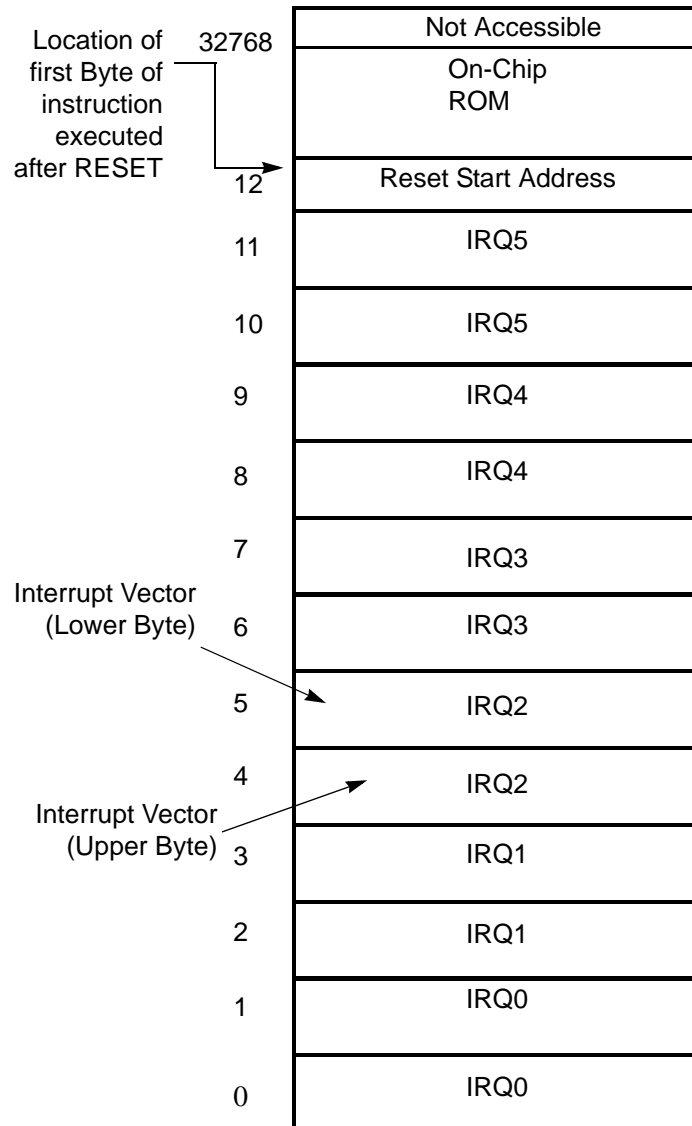


Figure 14. Program Memory Map (32K OTP)

## Expanded Register File

The register file has been expanded to allow for additional system control registers and for mapping of additional peripheral devices into the register address area. The Z8® register address space (R0 through R15) has been implemented as 16 banks, with 16 registers per bank. These register groups are known as the

### Counter/Timer2 LS-Byte Hold Register—TC16L(D)06H

Field	Bit Position	Description
T16_Data_LO	[7:0]	R/W Data

### Counter/Timer8 High Hold Register—TC8H(D)05H

Field	Bit Position	Description
T8_Level_HI	[7:0]	R/W Data

### Counter/Timer8 Low Hold Register—TC8L(D)04H

Field	Bit Position	Description
T8_Level_LO	[7:0]	R/W Data

### CTR0 Counter/Timer8 Control Register—CTR0(D)00H

Table 12 lists and briefly describes the fields for this register.

**Table 12. CTR0(D)00H Counter/Timer8 Control Register**

Field	Bit Position		Value	Description
T8_Enable	7-----	R/W	0*	Counter Disabled
			1	Counter Enabled
			0	Stop Counter
			1	Enable Counter
Single/Modulo-N	-6-----	R/W	0	Modulo-N
			1	Single Pass
Time_Out	--5-----	R/W	0	No Counter Time-Out
			1	Counter Time-Out Occurred
			0	No Effect
			1	Reset Flag to 0
T8_Clock	---43---	R/W	0 0	SCLK
			0 1	SCLK/2
			1 0	SCLK/4
			1 1	SCLK/8
Capture_INT_Mask	----2--	R/W	0	Disable Data Capture Interrupt
			1	Enable Data Capture Interrupt



Table 12. CTR0(D)00H Counter/Timer8 Control Register (Continued)

Field	Bit Position		Value	Description
Counter_INT_Mask	-----1-	R/W	0	Disable Time-Out Interrupt
			1	Enable Time-Out Interrupt
P34_Out	-----0	R/W	0*	P34 as Port Output
			1	T8 Output on P34

**Note:**

\*Indicates the value upon Power-On Reset.

**T8 Enable**

This field enables T8 when set (written) to 1.

**Single/Modulo-N**

When set to 0 (Modulo-N), the counter reloads the initial value when the terminal count is reached. When set to 1 (single-pass), the counter stops when the terminal count is reached.

**Timeout**

This bit is set when T8 times out (terminal count reached). To reset this bit, write a 1 to its location.



**Caution:** Writing a 1 is the only way to reset the Terminal Count status condition. Reset this bit before using/enabling the counter/timers.

The first clock of T8 might not have complete clock width and can occur any time when enabled.



**Note:** Take care when using the OR or AND commands to manipulate CTR0, bit 5 and CTR1, bits 0 and 1 (Demodulation Mode). These instructions use a Read-Modify-Write sequence in which the current status from the CTR0 and CTR1 registers is ORed or ANDed with the designated value and then written back into the registers.

**T8 Clock**

This bit defines the frequency of the input signal to T8.

### Capture\_INT\_Mask

Set this bit to allow an interrupt when data is captured into either LO8 or HI8 upon a positive or negative edge detection in demodulation mode.

### Counter\_INT\_Mask

Set this bit to allow an interrupt when T8 has a timeout.

### P34\_Out

This bit defines whether P34 is used as a normal output pin or the T8 output.

### T8 and T16 Common Functions—CTR1(0D)01H

This register controls the functions in common with the T8 and T16.

Table 13 lists and briefly describes the fields for this register.

**Table 13. CTR1(0D)01H T8 and T16 Common Functions**

Field	Bit Position		Value	Description
Mode	7-----	R/W	0*	Transmit Mode Demodulation Mode
P36_Out/ Demodulator_Input	-6-----	R/W	0* 1  0 1	Transmit Mode Port Output T8/T16 Output Demodulation Mode P31 P20
T8/T16_Logic/ Edge_Detect	--54----	R/W	00** 01 10 11  00** 01 10 11	Transmit Mode AND OR NOR NAND Demodulation Mode Falling Edge Rising Edge Both Edges Reserved

into LO8; if it is a negative edge, data is put into HI8. From that point, one of the edge detect status bits (CTR1, D1; D0) is set, and an interrupt can be generated if enabled (CTR0, D2). Meanwhile, T8 is loaded with FFh and starts counting again. If T8 reaches 0, the timeout status bit (CTR0, D5) is set, and an interrupt can be generated if enabled (CTR0, D1). T8 then continues counting from FFh (see Figure 23 and Figure 24).

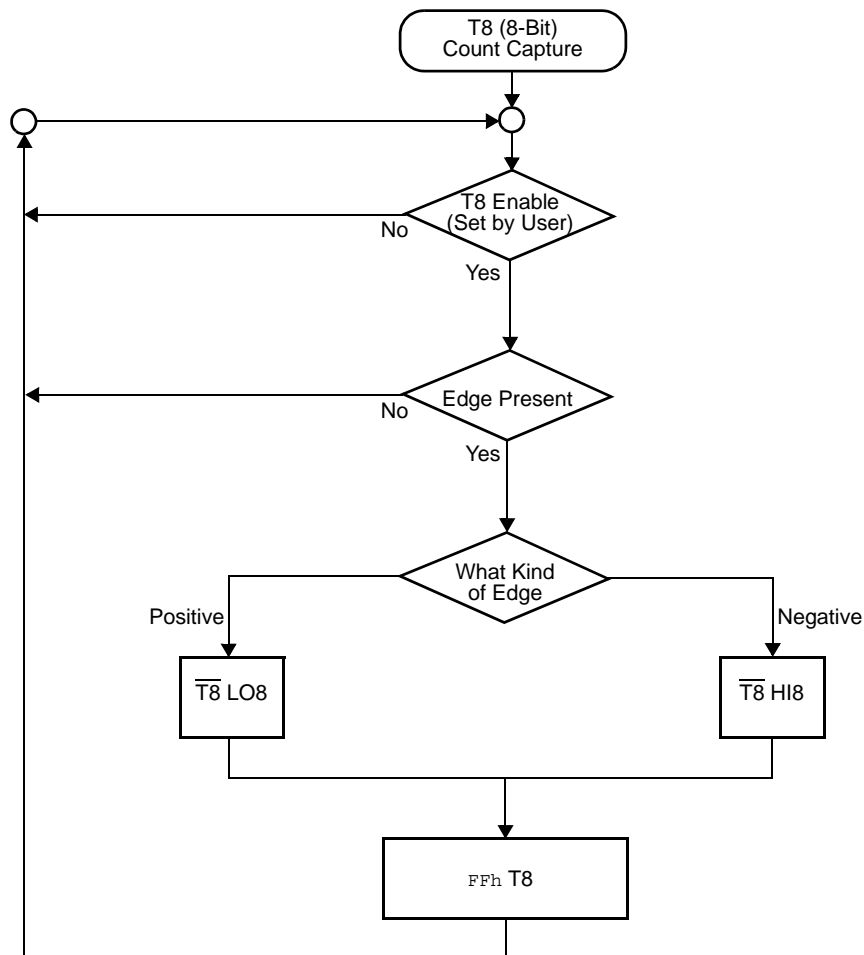


Figure 23. Demodulation Mode Count Capture Flowchart

**Table 16. Interrupt Types, Sources, and Vectors**

Name	Source	Vector Location	Comments
IRQ0	P32	0,1	External (P32), Rising, Falling Edge Triggered
IRQ1	P33	2,3	External (P33), Falling Edge Triggered
IRQ2	P31, T <sub>IN</sub>	4,5	External (P31), Rising, Falling Edge Triggered
IRQ3	T16	6,7	Internal
IRQ4	T8	8,9	Internal
IRQ5	LVD	10,11	Internal

When more than one interrupt is pending, priorities are resolved by a programmable priority encoder controlled by the Interrupt Priority Register. An interrupt machine cycle activates when an interrupt request is granted. As a result, all subsequent interrupts are disabled, and the Program Counter and Status Flags are saved. The cycle then branches to the program memory vector location reserved for that interrupt. All Z8 GP™ OTP MCU Family interrupts are vectored through locations in the program memory. This memory location and the next byte contain the 16-bit address of the interrupt service routine for that particular interrupt request. To accommodate polled interrupt systems, interrupt inputs are masked, and the Interrupt Request register is polled to determine which of the interrupt requests require service.

An interrupt resulting from AN1 is mapped into IRQ2, and an interrupt from AN2 is mapped into IRQ0. Interrupts IRQ2 and IRQ0 can be rising, falling, or both edge triggered. These interrupts are programmable by the user. The software can poll to identify the state of the pin.

Programming bits for the Interrupt Edge Select are located in the IRQ Register (R250), bits D7 and D6. The configuration is indicated in Table 17.

**Table 17. IRQ Register**

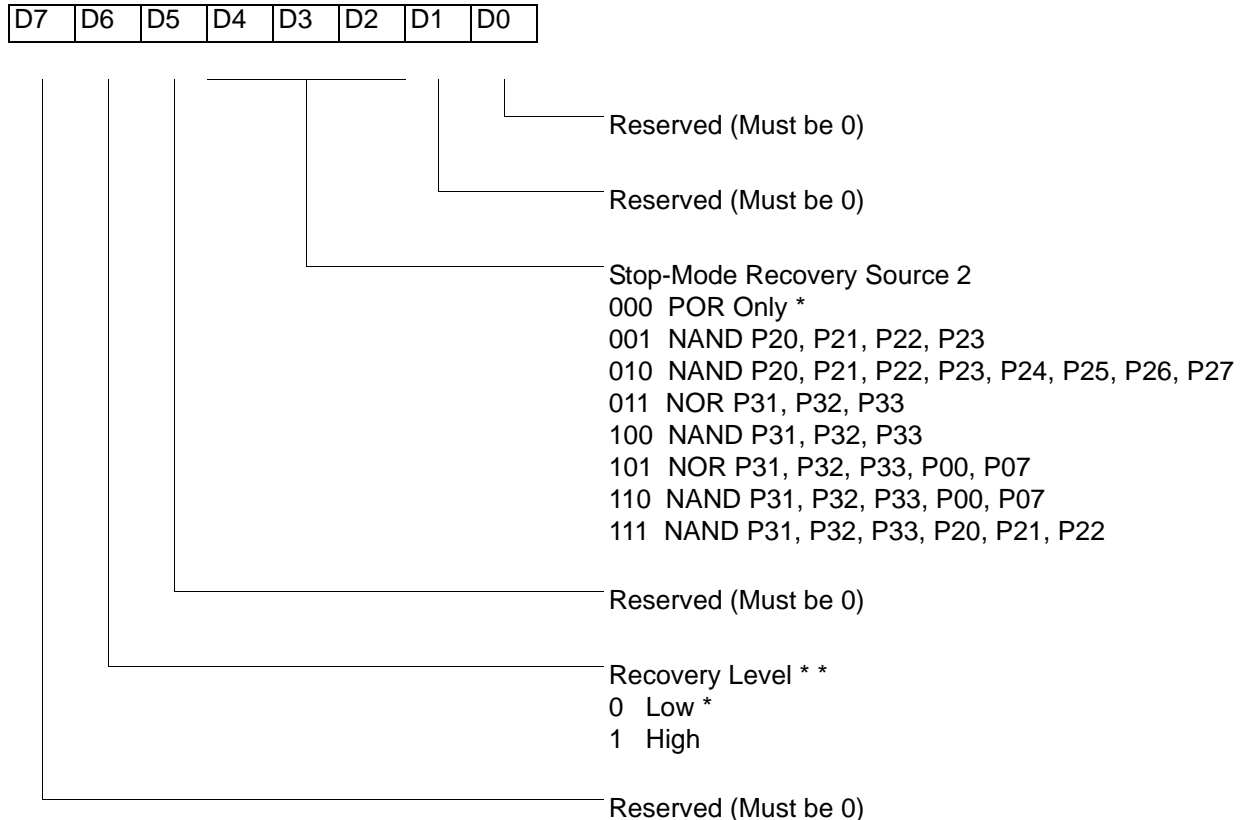
IRQ		Interrupt Edge	
D7	D6	IRQ2 (P31)	IRQ0 (P32)
0	0	F	F
0	1	F	R
1	0	R	F
1	1	R/F	R/F

**Note:** F = Falling Edge; R = Rising Edge

## Stop Mode Recovery Register 2 (SMR2)

This register determines the mode of Stop Mode Recovery for SMR2 (Figure 36).

SMR2(0F)DH



Note: If used in conjunction with SMR, either of the two specified events causes a Stop-Mode Recovery.

\* Default setting after reset

\*\* At the XOR gate input

**Figure 36. Stop Mode Recovery Register 2 ((0F)DH:D2–D4, D6 Write Only)**

If SMR2 is used in conjunction with SMR, either of the specified events causes a Stop Mode Recovery.

► **Note:** Port pins configured as outputs are ignored as an SMR or SMR2 recovery source. For example, if the NAND or P23–P20 is selected as the recovery source and P20 is configured as an output, the remaining SMR pins (P23–P21) form the NAND equation.

### Low-Voltage Detection Register—LVD(D)0Ch

- **Note:** Voltage detection does not work at Stop mode. It must be disabled during Stop mode in order to reduce current.

Field	Bit Position	Description		
LVD	76543---	Reserved No Effect		
	----2--	R	1 0*	HVD flag set HVD flag reset
	-----1-	R	1 0*	LVD flag set LVD flag reset
	-----0	R/W	1 0*	Enable VD Disable VD

\*Default after POR

- **Note:** Do not modify register P01M while checking a low-voltage condition. Switching noise of both ports 0 and 1 together might trigger the LVD flag.

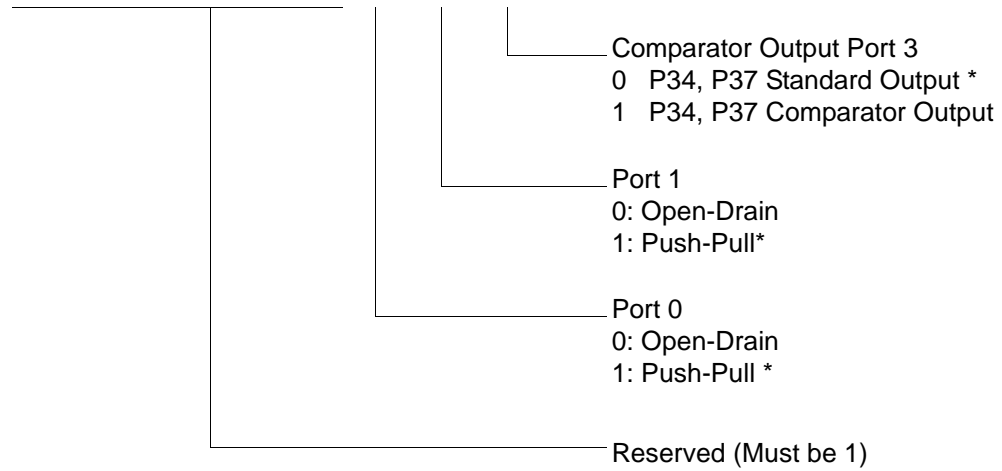
### Voltage Detection and Flags

The Voltage Detection register (LVD, register 0CH at the expanded register bank 0Dh) offers an option of monitoring the  $V_{CC}$  voltage. The Voltage Detection is enabled when bit 0 of LVD register is set. Once Voltage Detection is enabled, the  $V_{CC}$  level is monitored in real time. The flags in the LVD register valid 20uS after Voltage Detection is enabled. The HVD flag (bit 2 of the LVD register) is set only if  $V_{CC}$  is higher than  $V_{HVD}$ . The LVD flag (bit 1 of the LVD register) is set only if  $V_{CC}$  is lower than the  $V_{LVD}$ . When Voltage Detection is enabled, the LVD flag also triggers IRQ5. The IRQ bit 5 latches the low voltage condition until it is cleared by instructions or reset. The IRQ5 interrupt is served if it is enabled in the IMR register. Otherwise, bit 5 of IRQ register is latched as a flag only.

- **Notes:** If it is necessary to receive an LVD interrupt upon power-up at an operating voltage lower than the low battery detect threshold, enable interrupts using the Enable Interrupt instruction (EI) prior to enabling the voltage detection.

PCON(0F)00H

D7	D6	D5	D4	D3	D2	D1	D0
----	----	----	----	----	----	----	----

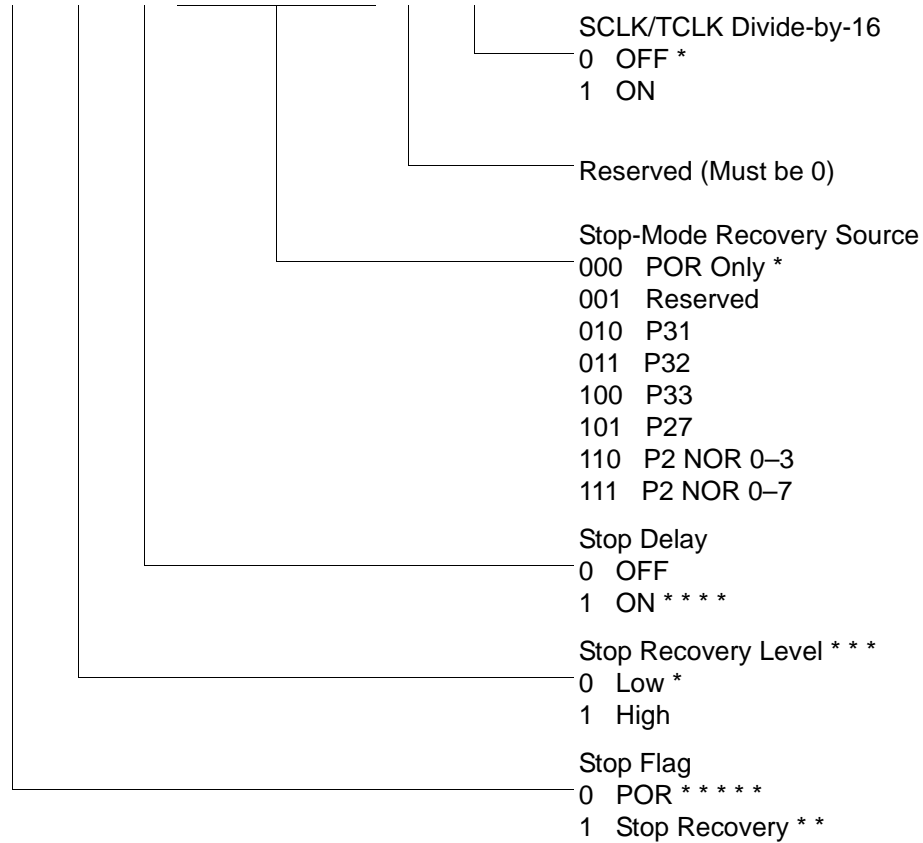


\* Default setting after reset

**Figure 44. Port Configuration Register (PCON)(0F)00H: Write Only)**

SMR(0F)0BH

D7	D6	D5	D4	D3	D2	D1	D0
----	----	----	----	----	----	----	----



\* Default setting after Reset

\* \* Set after STOP Mode Recovery

\* \* \* At the XOR gate input

\* \* \* \* Default setting after Reset. Must be 1 if using a crystal or resonator clock source.

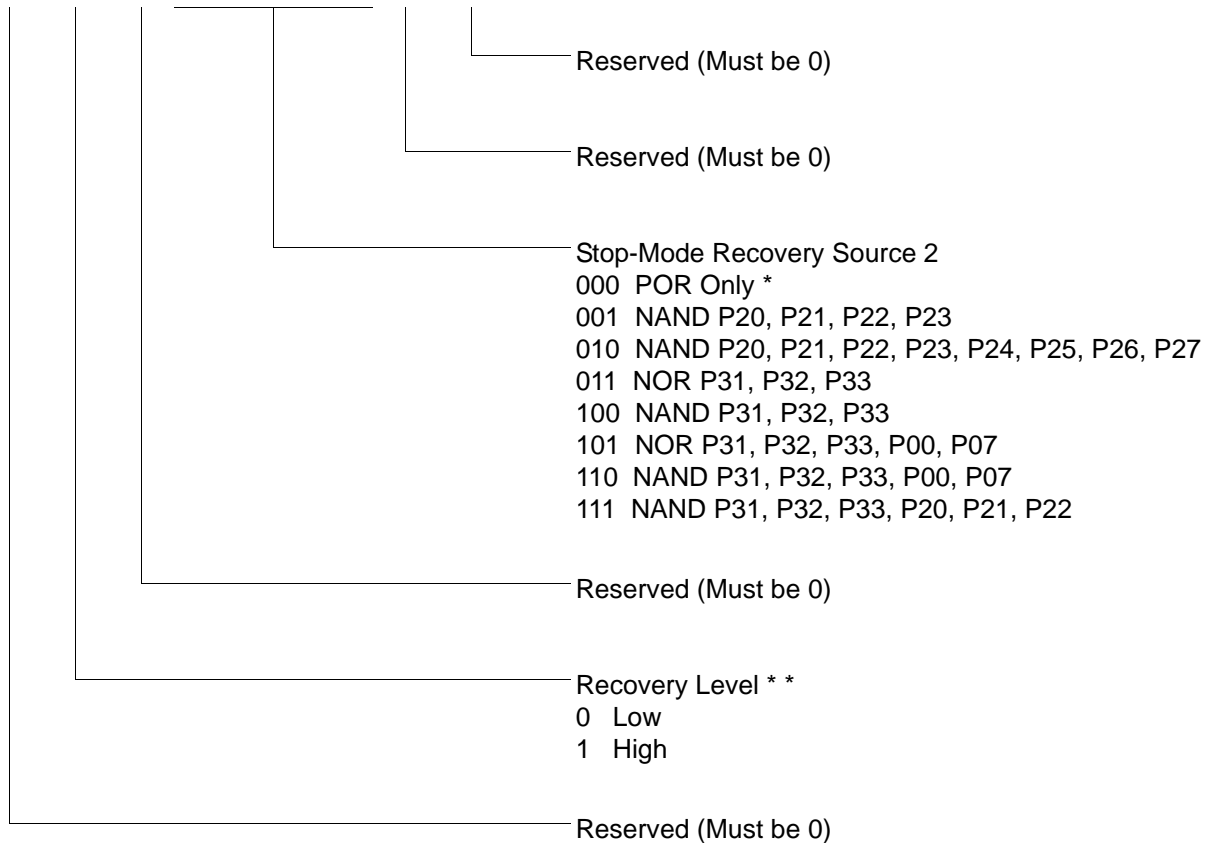
\* \* \* \* \* Default setting after Power On Reset. Not Reset with a Stop Mode recovery.

**Figure 45. Stop Mode Recovery Register ((0F)0BH: D6–D0=Write Only, D7=Read Only)**



SMR2(0F)0DH

D7	D6	D5	D4	D3	D2	D1	D0
----	----	----	----	----	----	----	----



Note: If used in conjunction with SMR, either of the two specified events causes a Stop-Mode Recovery.

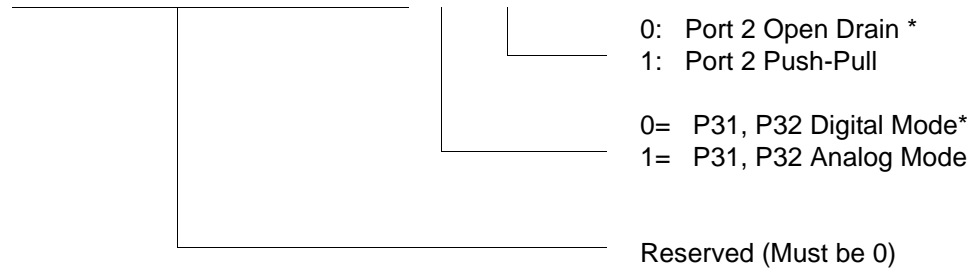
\* Default setting after reset

\* \* At the XOR gate input

Figure 46. Stop Mode Recovery Register 2 ((0F)0DH:D2–D4, D6 Write Only)

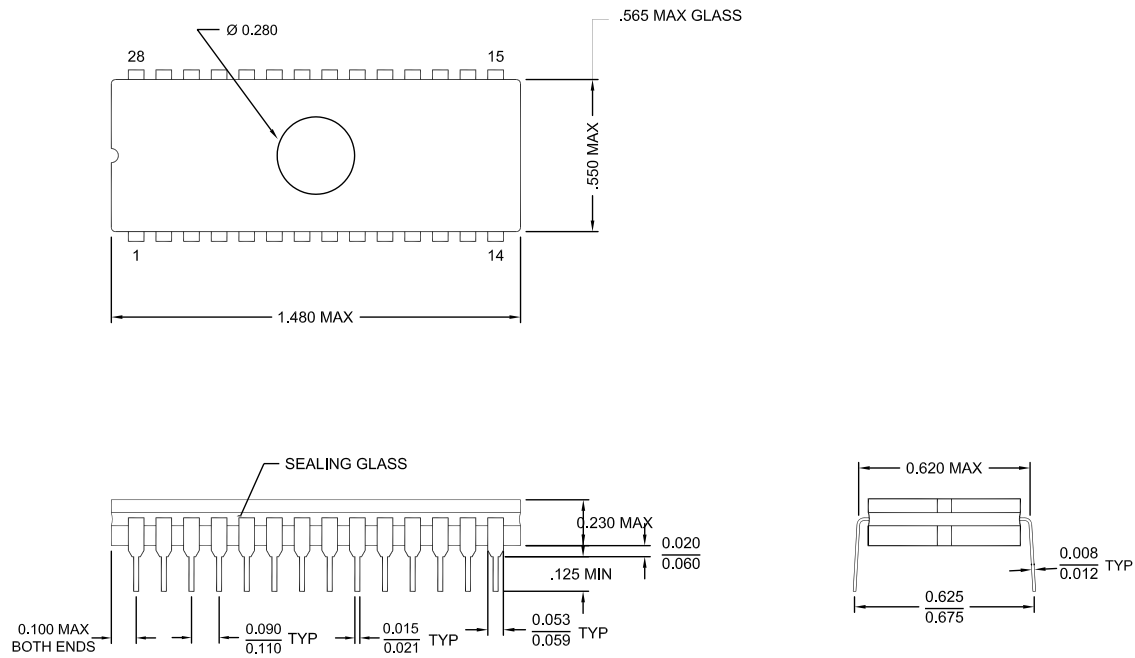
R247 P3M(F7H)

D7	D6	D5	D4	D3	D2	D1	D0
----	----	----	----	----	----	----	----



\* Default setting after reset. Not reset with Stop Mode recovery.

**Figure 49. Port 3 Mode Register (F7H: Write Only)**



**Figure 62. 28-Pin CDIP Package**

**16KB Standard Temperature: 0° to +70°C**

Part Number	Description	Part Number	Description
ZGP323LSH4816C	48-pin SSOP 16K OTP	ZGP323LSS2816C	28-pin SOIC 16K OTP
ZGP323LSP4016C	40-pin PDIP 16K OTP	ZGP323LSH2016C	20-pin SSOP 16K OTP
ZGP323LSH2816C	28-pin SSOP 16K OTP	ZGP323LSP2016C	20-pin PDIP 16K OTP
ZGP323LSP2816C	28-pin PDIP 16K OTP	ZGP323LSS2016C	20-pin SOIC 16K OTP

**16KB Extended Temperature: -40° to +105°C**

Part Number	Description	Part Number	Description
ZGP323LEH4816C	48-pin SSOP 16K OTP	ZGP323LES2816C	28-pin SOIC 16K OTP
ZGP323LEP4016C	40-pin PDIP 16K OTP	ZGP323LES2016C	20-pin SOIC 16K OTP
ZGP323LEH2816C	28-pin SSOP 16K OTP	ZGP323LEH2016C	20-pin SSOP 16K OTP
ZGP323LEP2816C	28-pin PDIP 16K OTP	ZGP323LEP2016C	20-pin PDIP 16K OTP

**16KB Automotive Temperature: -40° to +125°C**

Part Number	Description	Part Number	Description
ZGP323LAH4816C	48-pin SSOP 16K OTP	ZGP323LAS2816C	28-pin SOIC 16K OTP
ZGP323LAP4016C	40-pin PDIP 16K OTP	ZGP323LAH2016C	20-pin SSOP 16K OTP
ZGP323LAH2816C	28-pin SSOP 16K OTP	ZGP323LAP2016C	20-pin PDIP 16K OTP
ZGP323LAP2816C	28-pin PDIP 16K OTP	ZGP323LAS2016C	20-pin SOIC 16K OTP

Note: Replace C with G for Lead-Free Packaging



For fast results, contact your local ZiLOG sales office for assistance in ordering the part desired.

**Codes**

ZG = ZiLOG General Purpose Family

P = OTP

323 = Family Designation

L = Voltage Range

2V to 3.6V

T = Temperature Range:

S = 0 to 70 degrees C (Standard)

E = -40 to +105 degrees C (Extended)

A = -40 to +125 degrees C (Automotive)

P = Package Type:

K = Windowed Cerdip

P = PDIP

H = SSOP

S = SOIC

## = Number of Pins

CC = Memory Size

M = Packaging Options

C = Non Lead-Free

G = Lead-Free

E = CDIP